# Triacs

## **Silicon Bidirectional Thyristors**

Designed for high performance full-wave ac control applications where high noise immunity and high commutating di/dt are required.

### Features

- Blocking Voltage to 800 Volts
- On–State Current Rating of 8.0 Amperes RMS at 100°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to  $dv/dt 500 V/\mu s$  minimum at  $125^{\circ}C$
- Minimizes Snubber Networks for Protection
- Industry Standard TO-220 Package
- High Commutating di/dt 6.5 A/ms minimum at 125°C
- These Devices are Pb-Free and are RoHS Compliant\*

### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

| Rating  | Symbol                                | Value             | Unit               |
|---|---------------------------------------|-------------------|--------------------|
| Peak Repetitive Off–State Voltage (Note 1)<br>( $T_J = -40$ to 125°C, Sine Wave,<br>50 to 60 Hz, Gate Open) | V <sub>DRM,</sub><br>V <sub>RRM</sub> |                   | V                  |
| MAC9D<br>MAC9M<br>MAC9N   |                                       | 400<br>600<br>800 |                    |
| On-State RMS Current<br>(Full Cycle Sine Wave, 60 Hz, T <sub>C</sub> = 100°C)                               | I <sub>T(RMS)</sub>                   | 8.0               | A                  |
| Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, $T_J = 125^{\circ}C$ )                  | I <sub>TSM</sub>                      | 80                | A                  |
| Circuit Fusing Consideration (t = 8.3 ms)   | l <sup>2</sup> t                      | 26                | A <sup>2</sup> sec |
| Peak Gate Power (Pulse Width $\leq$ 1.0 $\mu$ s, T <sub>C</sub> = 80°C)                                     | P <sub>GM</sub>                       | 16                | W                  |
| Average Gate Power<br>(t = 8.3 ms, $T_C = 80^{\circ}C$ )  | P <sub>G(AV)</sub>                    | 0.35              | W                  |
| Operating Junction Temperature Range  | TJ                                    | -40 to +125       | °C                 |
| Storage Temperature Range   | T <sub>stg</sub>                      | -40 to +150       | °C                 |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

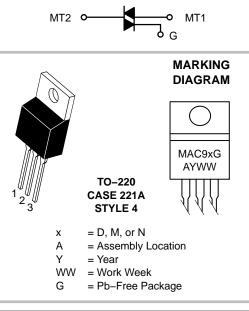
 V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



### **ON Semiconductor®**

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TRIACS 8 AMPERES RMS 400 thru 800 VOLTS



|   | PIN ASSIGNMENT  |
|---|-----------------|
| 1 | Main Terminal 1 |
| 2 | Main Terminal 2 |
| 3 | Gate            |
| 4 | Main Terminal 2 |
|   |                 |

### ORDERING INFORMATION

| Device | Package             | Shipping        |
|--------|---------------------|-----------------|
| MAC9DG | TO–220<br>(Pb–Free) | 50 Units / Rail |
| MAC9MG | TO-220<br>(Pb-Free) | 50 Units / Rail |
| MAC9NG | TO-220<br>(Pb-Free) | 50 Units / Rail |

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### THERMAL CHARACTERISTICS

| Characteristic  | Symbol  | Value       | Unit |
|---|---|-------------|------|
| Thermal Resistance,<br>Junction-to-Case<br>Junction-to-Ambient                | ${\sf R}_{	heta {\sf JC}} \ {\sf R}_{	heta {\sf JA}}$ | 2.2<br>62.5 | °C/W |
| Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds | ΤL  | 260         | °C   |

#### **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise noted; Electricals apply in both directions)

| Characteristic   | Symbol                                 | Min               | Тур                  | Max               | Unit |
|--|--|-------------------|----------------------|-------------------|------|
| OFF CHARACTERISTICS  |  |                   |                      |                   |      |
| Peak Repetitive Blocking Current<br>$(V_D = Rated V_{DRM}, V_{RRM}; Gate Open)$<br>$T_J = 25^{\circ}C$<br>$T_J = 125^{\circ}C$   | I <sub>DRM</sub> ,<br>I <sub>RRM</sub> |                   |                      | 0.01<br>2.0       | mA   |
| ON CHARACTERISTICS   | ·                                      | •                 | •                    | •                 | •    |
| Peak On-State Voltage (Note 2) $(I_{TM} = \pm 11 \text{ A Peak})$  | V <sub>TM</sub>                        | -                 | 1.2                  | 1.6               | V    |
| Gate Trigger Current (Continuous dc) ( $V_D = 12 V$ , $R_L = 100 \Omega$ )<br>MT2(+), G(+)<br>MT2(+), G(-)<br>MT2(-), G(-)   | I <sub>GT</sub>                        | 10<br>10<br>10    | 16<br>18<br>22       | 50<br>50<br>50    | mA   |
| Holding Current ( $V_D = 12 V$ , Gate Open, Initiating Current = ±150 mA)  | IH                                     | -                 | 30                   | 50                | mA   |
| Latching Current (V <sub>D</sub> = 24 V, I <sub>G</sub> = 50 mA)<br>MT2(+), G(+); MT2(-), G(-)<br>MT2(+), G(-)   | ۱                                      |                   | 20<br>30             | 50<br>80          | mA   |
| Gate Trigger Voltage (V <sub>D</sub> = 12 V, R <sub>L</sub> = 100 $\Omega$ )<br>MT2(+), G(+)<br>MT2(+), G(-)<br>MT2(-), G(-)   | V <sub>GT</sub>                        | 0.5<br>0.5<br>0.5 | 0.69<br>0.77<br>0.72 | 1.5<br>1.5<br>1.5 | V    |
| Gate Non–Trigger Voltage (V <sub>D</sub> = 12 V, R <sub>L</sub> = 100 $\Omega$ , T <sub>J</sub> = 125°C)<br>MT2(+), G(+); MT2(+), G(-); MT2(-), G(-)   | V <sub>GD</sub>                        | 0.2               | _                    | _                 | V    |
| DYNAMIC CHARACTERISTICS  | ·                                      |                   |                      | •                 | •    |
| Rate of Change of Commutating Current; See Figure 10.<br>( $V_D = 400 \text{ V}$ , $I_{TM} = 4.4 \text{ A}$ , Commutating dv/dt = 18 V/µs,<br>Gate Open, $T_J = 125^{\circ}$ C, f = 250 Hz, No Snubber)<br>$C_L = 10 \ \mu\text{F}$<br>$L_L = 40 \text{ mH}$ | (di/dt) <sub>c</sub>                   | 6.5               | -                    |                   | A/ms |

Critical Rate of Rise of Off-State Voltage  $(V_D = Rated V_{DRM}, Exponential Waveform, Gate Open, T_J = 125^{\circ}C)$ 

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Indicates Pulse Test: Pulse Width  $\leq$  2.0 ms, Duty Cycle  $\leq$  2%.

dv/dt

500

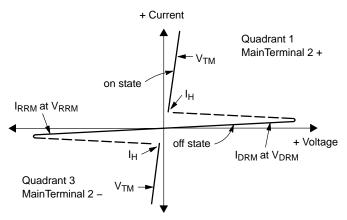
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V/µs

### Voltage Current Characteristic of Triacs (Bidirectional Device)

| Symbol           | Parameter                                 |
|------------------|---|
| V <sub>DRM</sub> | Peak Repetitive Forward Off State Voltage |
| I <sub>DRM</sub> | Peak Forward Blocking Current             |
| V <sub>RRM</sub> | Peak Repetitive Reverse Off State Voltage |
| I <sub>RRM</sub> | Peak Reverse Blocking Current             |
| $V_{TM}$         | Maximum On State Voltage                  |
| Ι <sub>Η</sub>   | Holding Current                           |

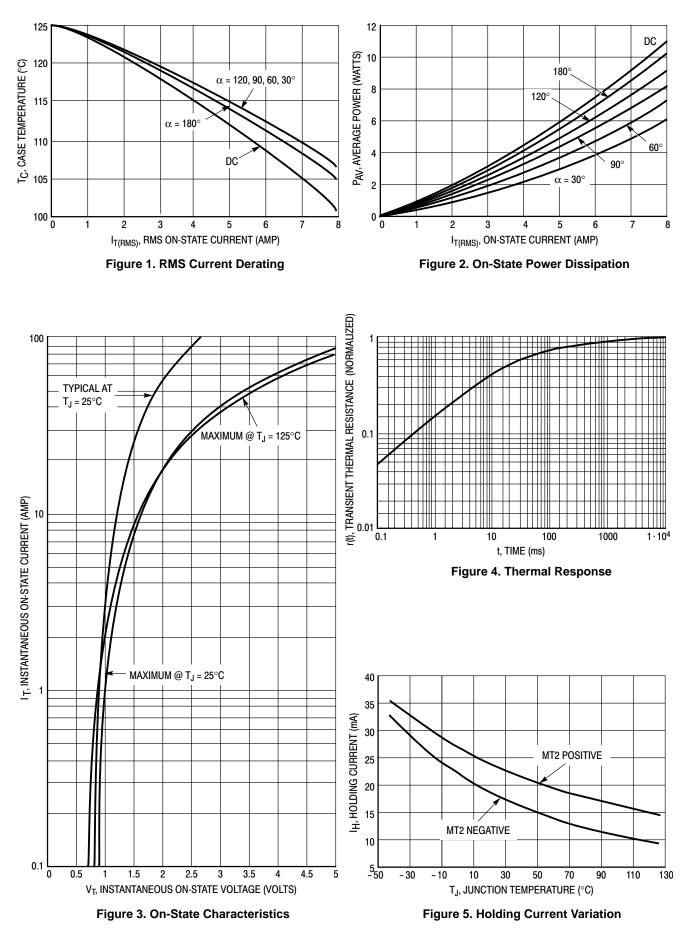


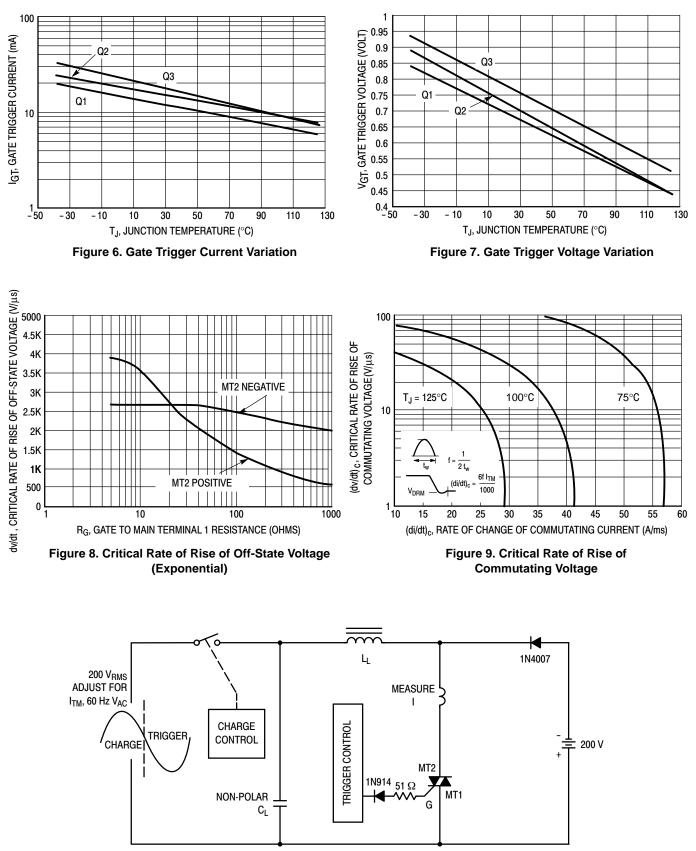
#### MT2 POSITIVE (Positive Half Cycle) + (+) MT2 (+) MT2 Quadrant II (+) I<sub>GT</sub> Quadrant I (–) I<sub>GT</sub> 0 o **ф** МТ1 **ф** МТ1 --REF REF I<sub>GT</sub> + I<sub>GT</sub> (-) MT2 (-) MT2 Quadrant III **Quadrant IV** (+) I<sub>GT</sub> GATE (–) I<sub>GT</sub> GATE 0 0 MT1 **ф** МТ1 Ξ Ξ REF REF MT2 NEGATIVE (Negative Half Cycle)

### **Quadrant Definitions for a Triac**

All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.



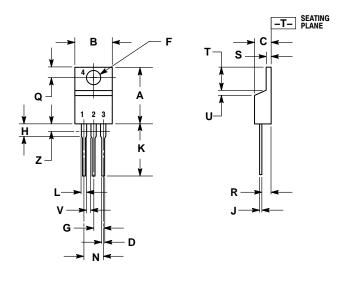


Note: Component values are for verification of rated (di/dt)<sub>c</sub>. See AN1048 for additional information.



#### PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH** 



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALL OWED 3

|     | INCHES |       | MILLIMETER |       |  |
|-----|--------|-------|------------|-------|--|
| DIM | MIN    | MAX   | MIN MAX    |       |  |
| Α   | 0.570  | 0.620 | 14.48      | 15.75 |  |
| В   | 0.380  | 0.415 | 9.66       | 10.53 |  |
| С   | 0.160  | 0.190 | 4.07       | 4.83  |  |
| D   | 0.025  | 0.038 | 0.64       | 0.96  |  |
| F   | 0.142  | 0.161 | 3.61       | 4.09  |  |
| G   | 0.095  | 0.105 | 2.42       | 2.66  |  |
| Н   | 0.110  | 0.161 | 2.80       | 4.10  |  |
| J   | 0.014  | 0.024 | 0.36       | 0.61  |  |
| κ   | 0.500  | 0.562 | 12.70      | 14.27 |  |
| L   | 0.045  | 0.060 | 1.15       | 1.52  |  |
| Ν   | 0.190  | 0.210 | 4.83       | 5.33  |  |
| Q   | 0.100  | 0.120 | 2.54       | 3.04  |  |
| R   | 0.080  | 0.110 | 2.04       | 2.79  |  |
| S   | 0.045  | 0.055 | 1.15       | 1.39  |  |
| Т   | 0.235  | 0.255 | 5.97       | 6.47  |  |
| U   | 0.000  | 0.050 | 0.00       | 1.27  |  |
| ۷   | 0.045  |       | 1.15       |       |  |
| Ζ   |        | 0.080 |            | 2.04  |  |

STYLE 4: PIN 1. MAIN TERMINAL 1 MAIN TERMINAL 2 2. 3. GATE MAIN TERMINAL 2 Λ

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